


| SYMBOL | MIN | NOM | MAX |
|--------|--------|------|------|
| A | 0.7 | 0.75 | 0.8 |
| A1 | — | 0.02 | 0.05 |
| b | 0.15 | 0.20 | 0.25 |
| c | 0.18 | 0.2 | 0.25 |
| D | 3.9 | 4.0 | 4.1 |
| D2 | 2.6 | 2.7 | 2.8 |
| e | 0.4BSC | | |
| Nd/Ne | 2.8BSC | | |
| E | 3.9 | 4.0 | 4.1 |
| E2 | 2.6 | 2.7 | 2.8 |
| L | 0.35 | 0.4 | 0.45 |
| R | 0.2BSC | | |

NOTES:
 1. ALL DIMENSIONS REFER TO JEDEC STANDARD MO-229 (WEED-4/WEED-4)
 2. DIMENSION D DOES NOT INCLUDE MOLD FLASH
 3. DIMENSION E1 DOES NOT INCLUDE MOLD FLASH
 4. FLASH OR PROTRUSION SHALL NOT EXCEED 0.25mm PER SIDE.

| | | | |
|-----------------------------------------------------------------------------------------------------|-------------|-------------------------------------------------------|---------------------------------|
|  GIGA FORCE | | 上海季丰电子科技股份有限公司 GIGA FORCE ELECTRONICS CO., Limited | |
| 制图 | 王磊 | Title | QFN32L (4X4X0.75)-P0.4 (CU&PPF) |
| 核准 | 何桂港 | POD No | POD-SHJF-15 |
| 日期 | 2022. 3. 31 | DIMENSIONS IN: | mm Rev: A |